HERD – SCD meeting

Mechanics status

02/06/2023

E. Mancini, L. Mussolin, G. Ambrosi



Brief agenda

- Square silicon side size reduced
- Fan-out electronics, new envelope
- Front-end electronics and cabling clearance
- SCD side, fixations to ground

NOTE: purple is used for things added during or after the meeting

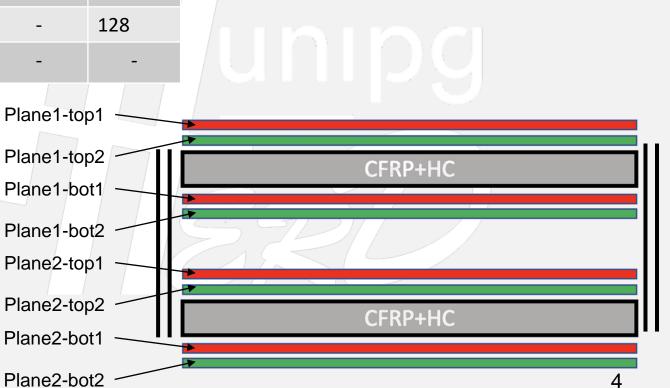
Detector size update

Detector specs.



Top pack	No. of tiles X*	No. of tiles Y*
Plane1-top1	-	256
Plane1-top2	256	-
Plane1-bot1	256	-
Plane1-bot2	-	256
Same for plane 2	-	-

side pack	No. of tiles X*	No. of tiles Y*
Plane1-top1	-	128
Plane1-top2	128	-
Plane1-bot1	128	-
Plane1-bot2	-	128
Same for plane 2	-	-
	1	1 1 1



Total number of tiles top: 2048 Total number of tiles per side: 1024 Total number of tiles: 6144

Wrong color coding. The silicon orientation is sym. wrt the plane center

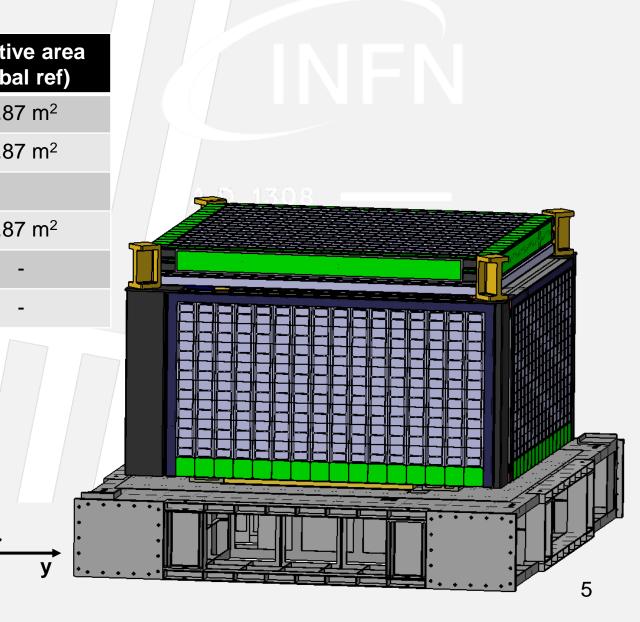


Detector specs.

Plane position (global ref)	Detective area X (global ref)	Detective area Y (global ref)	Detective area Z (global ref)
X+	-	4.87 m ²	4.87 m ²
X-	-	4.87 m ²	4.87 m ²
Y+	4.87 m ²	-	
Y-	4.87 m ²	-	4.87 m ²
Z+	9.73 m ²	9.73 m ²	-
Z-	-	-	-

Z

Total number of tiles top: 2048 Total number of tiles per side: 1024 Total number of tiles: 6144 Silicon size: 97.5 x 97.5 mm² Total silicon area: 58.41 m²



Detector specs.

6

ERD				
Plane position (global ref)	Detective area X (global ref)	Detective area Y (global ref)	Detect Z (glob	Is this enough for the SCD side
X+	-	4.87 m ²	4.	lateral bonds?
Х-	-	4.87 m ²	4.	.2 mm
Y+	4.87 m ²	-		
Y-	4.87 m ²	-	4.	
Z+	9.73 m ²	9.73 m ²		.2 mm
Z-	-	-		
Total number of ti Total number of ti Total number of ti Silicon size: 97.5 Total silicon area:	iles per side: 102 iles: 6144 x 97.5 mm²	24	Z 🔺	
Spacing between Spacing between				

×

NOTE: silicon spacing can be reduced on the side but on top it must be equal to the ladders'.

INF

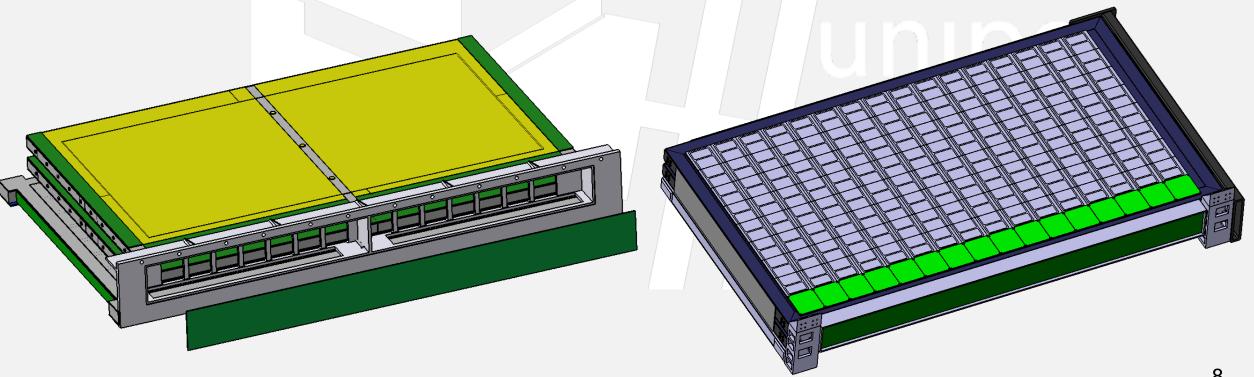
A.D. 1308 UNIPG

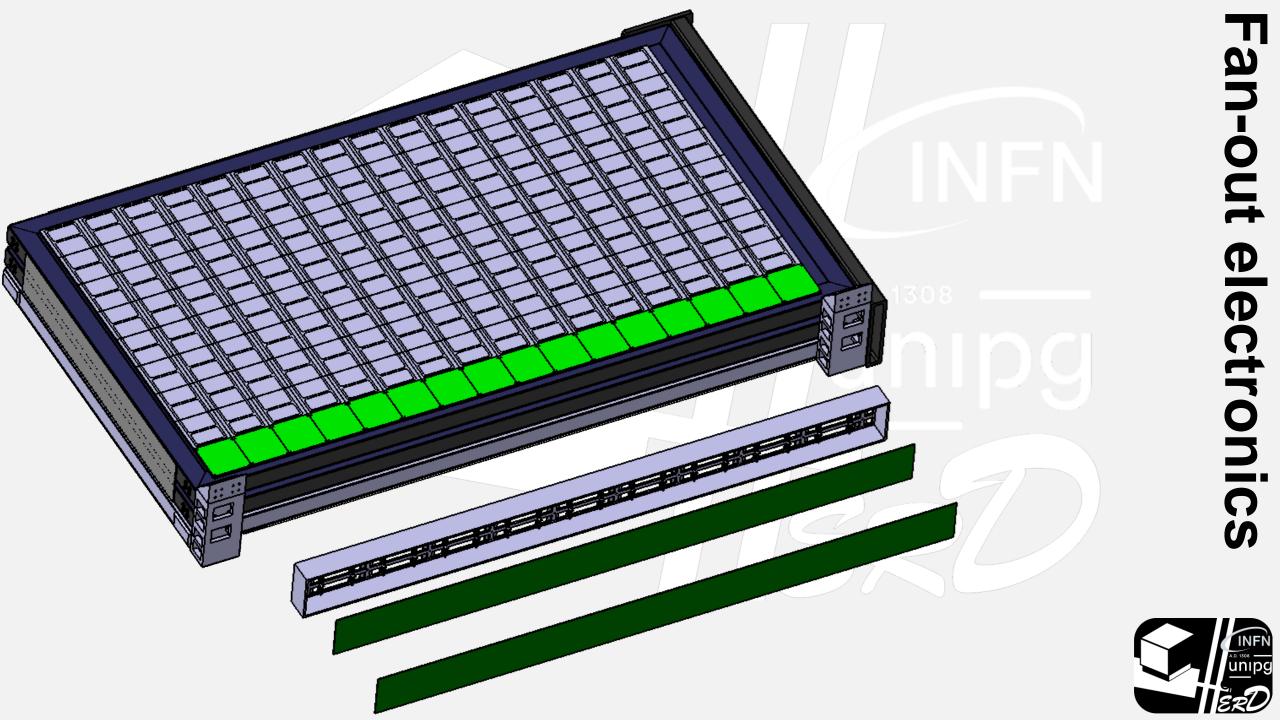
Fan-out electronics

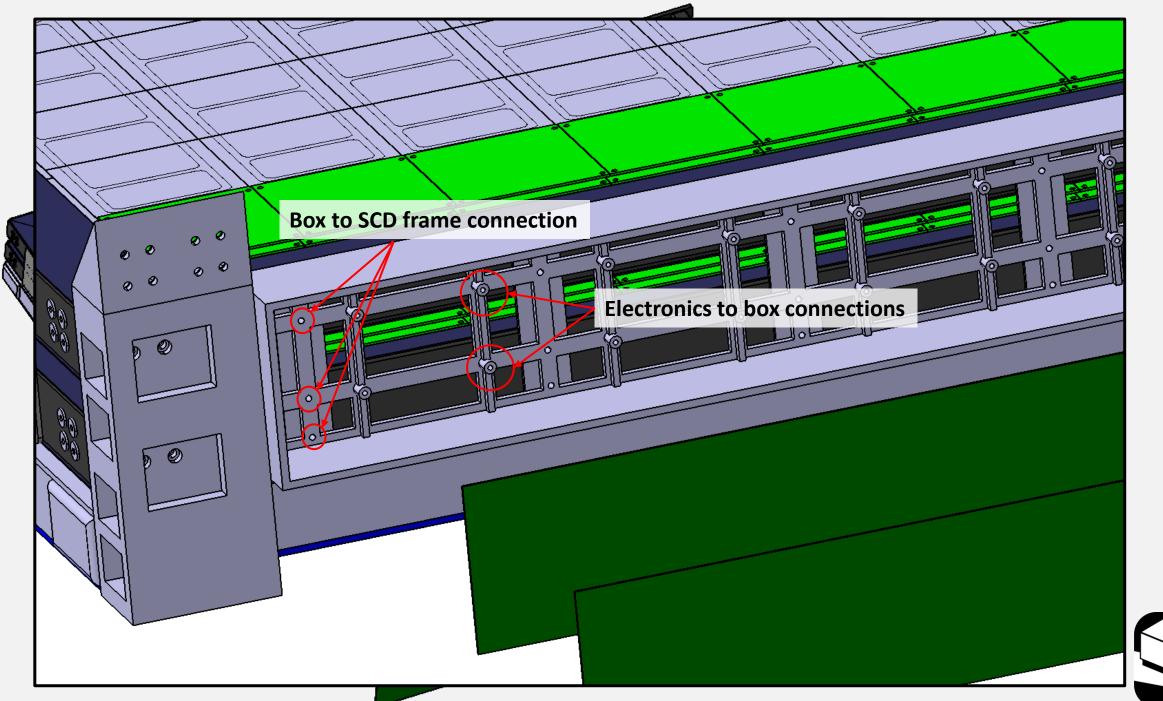


Fan-out electronics

- Old design: 1564x142 mm²
- PCB dimensions according to the present design: 1488x108 mm²









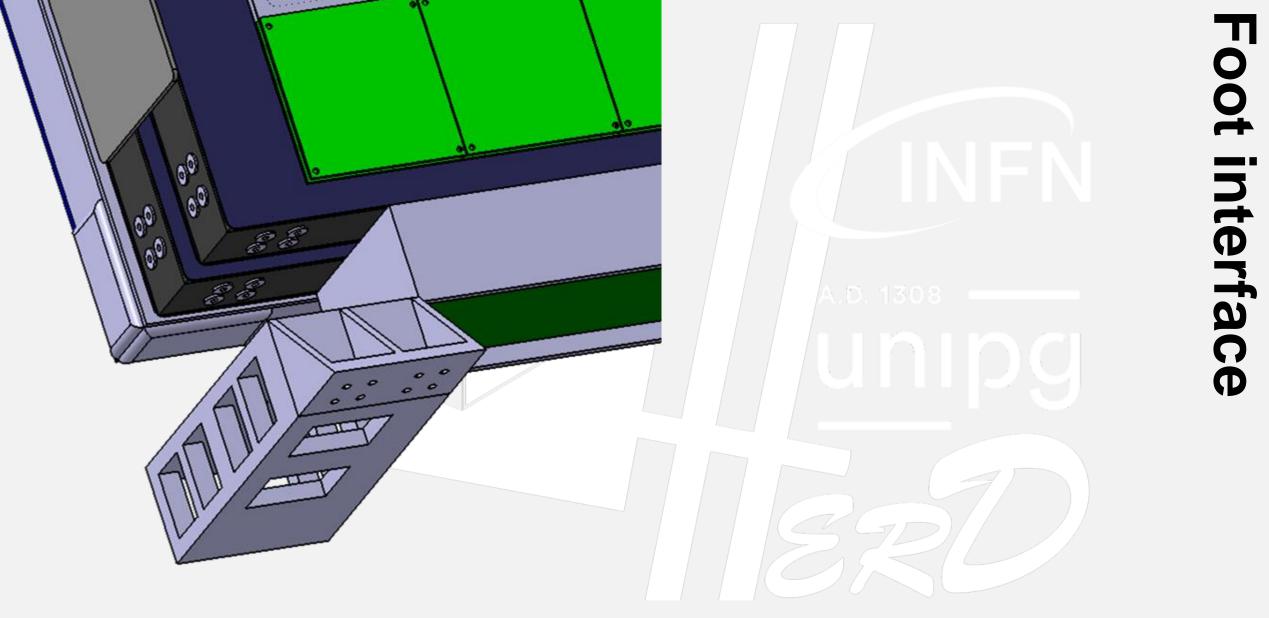


Discussion Gong-Edoardo-Rujie

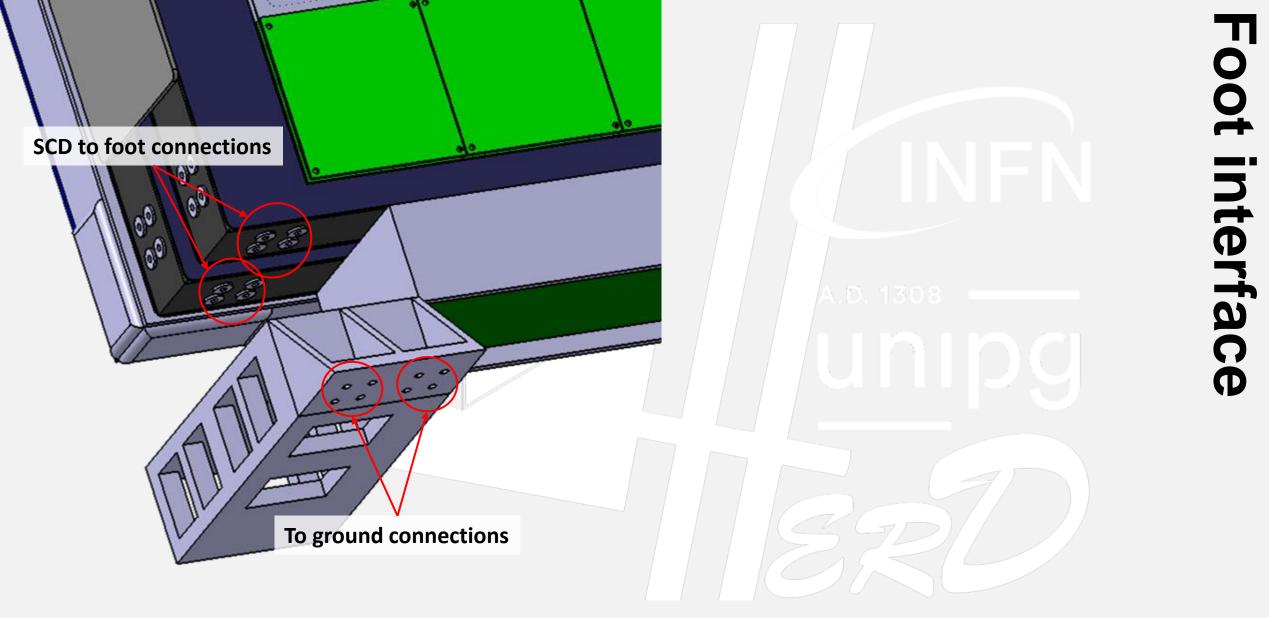
• Edoardo

- will try to reduce the feet dimensions so have an electronics size as close as possible to the detector size
- will send the updated CAD version to Rujie for thermal analysis.
 - Evaluate also the possibility to use the debris shield as a radiator along with the pipes (Rujie)
- Gong
 - will try to develop more than one front-end PCB design so to have the connector or the side and gain some space

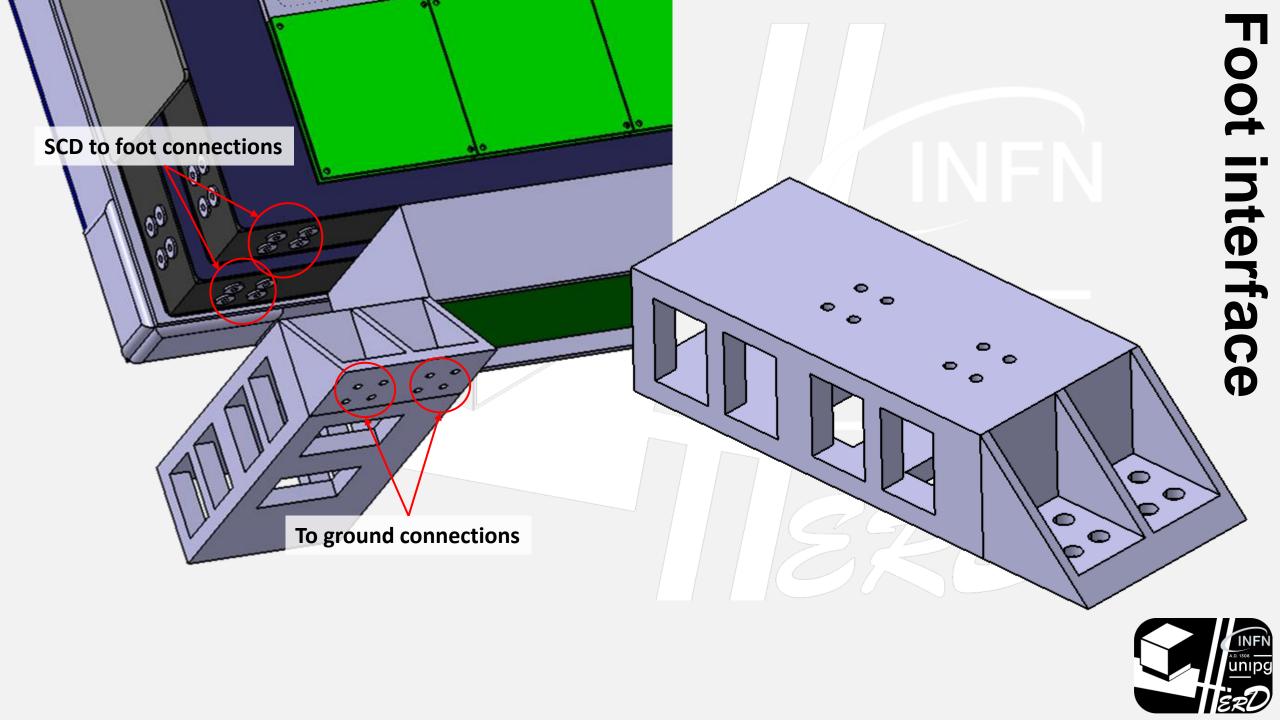
To ground mech. connection

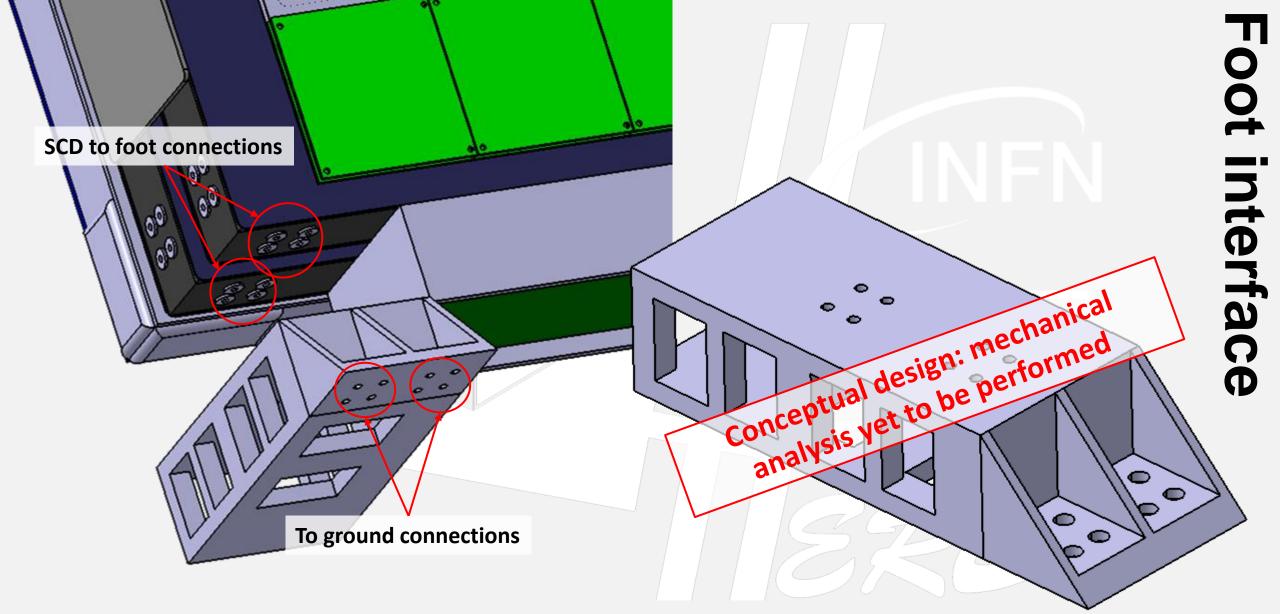












NOTE: the present design foreseen a feet front fixation. Accessibility consideration could lead to a both sides fixation which is better from a mechanical point of view



Front-end electronics



Front-end electronics

Questions:

- The top and side SCD have the same front-end electronics dimensions?
- Is the side clearance (20 mm) acceptable?
- Is the top clearance (25.8) acceptable?



Front-end size

Dimension of the present design:

- 100 mm x 97 mm
- .2 mm spacing between PCB and S

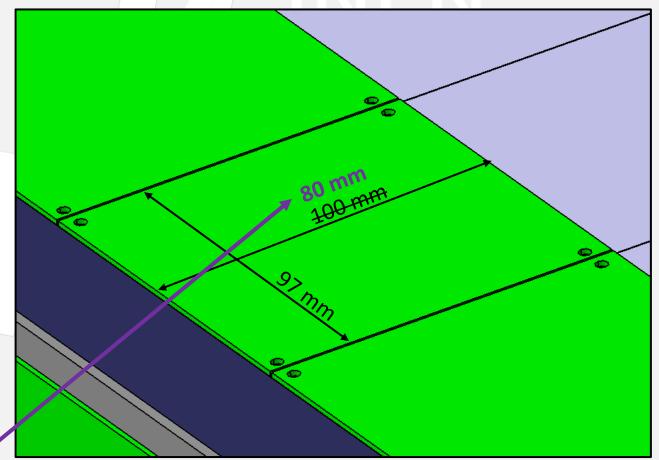
Dimension 1 (97 mm) constrained by silicon size and ladders' spacing:

- max: 97.5 mm + .2 mm margin*
- min: detector considerations (microbonds)

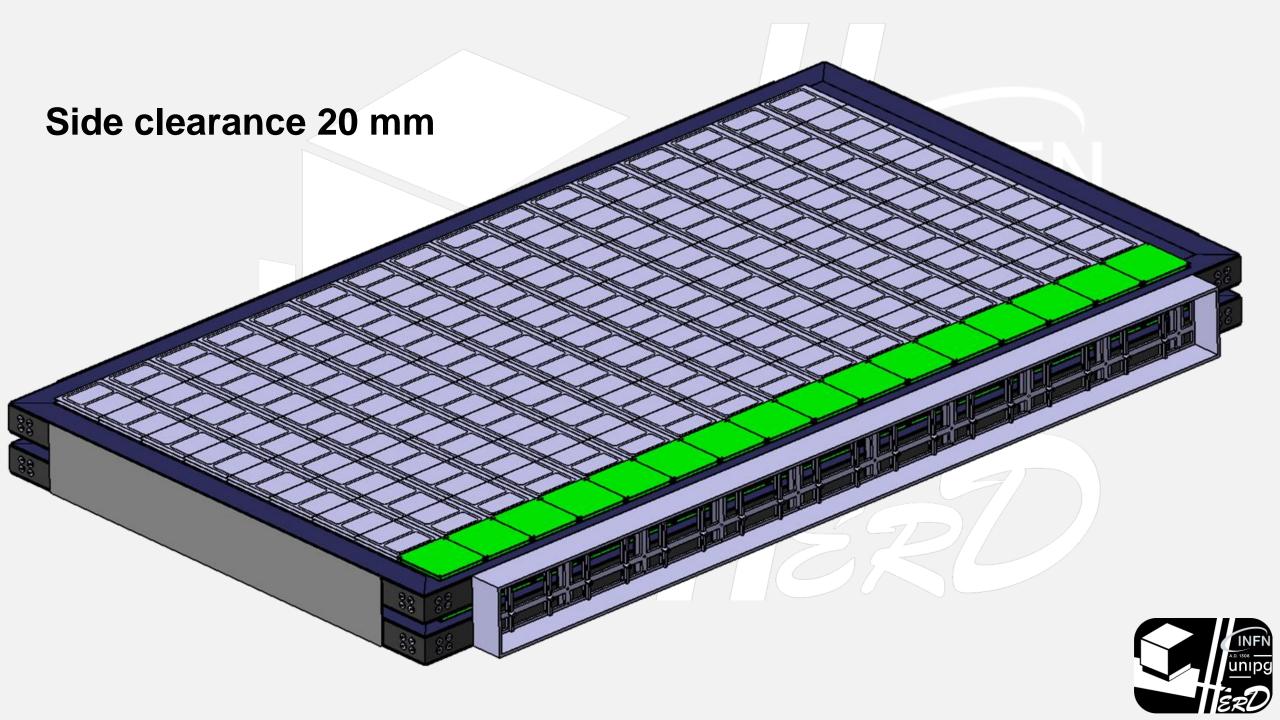
Dimension 2 (100 mm) unconstrained:

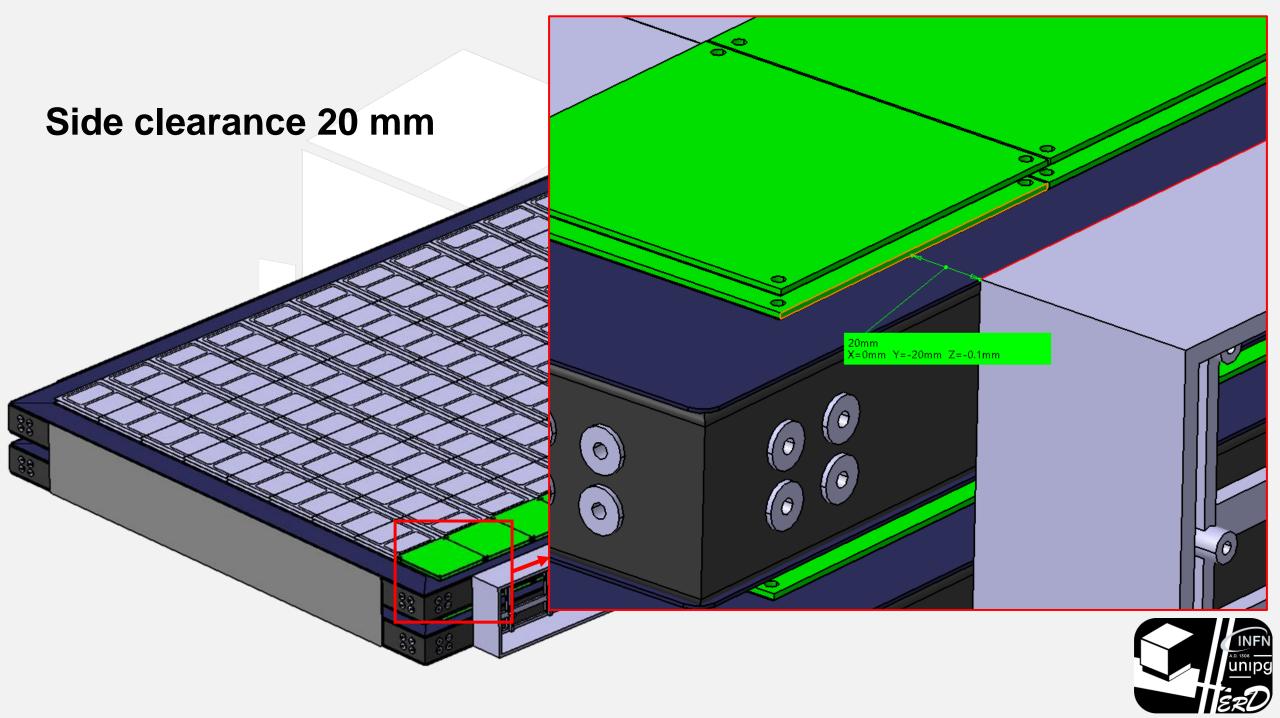
- The smaller the better. Every mm gained is added to the routing clearance
- Answer from Gong: yet to be defined. For now, go with 80 mm

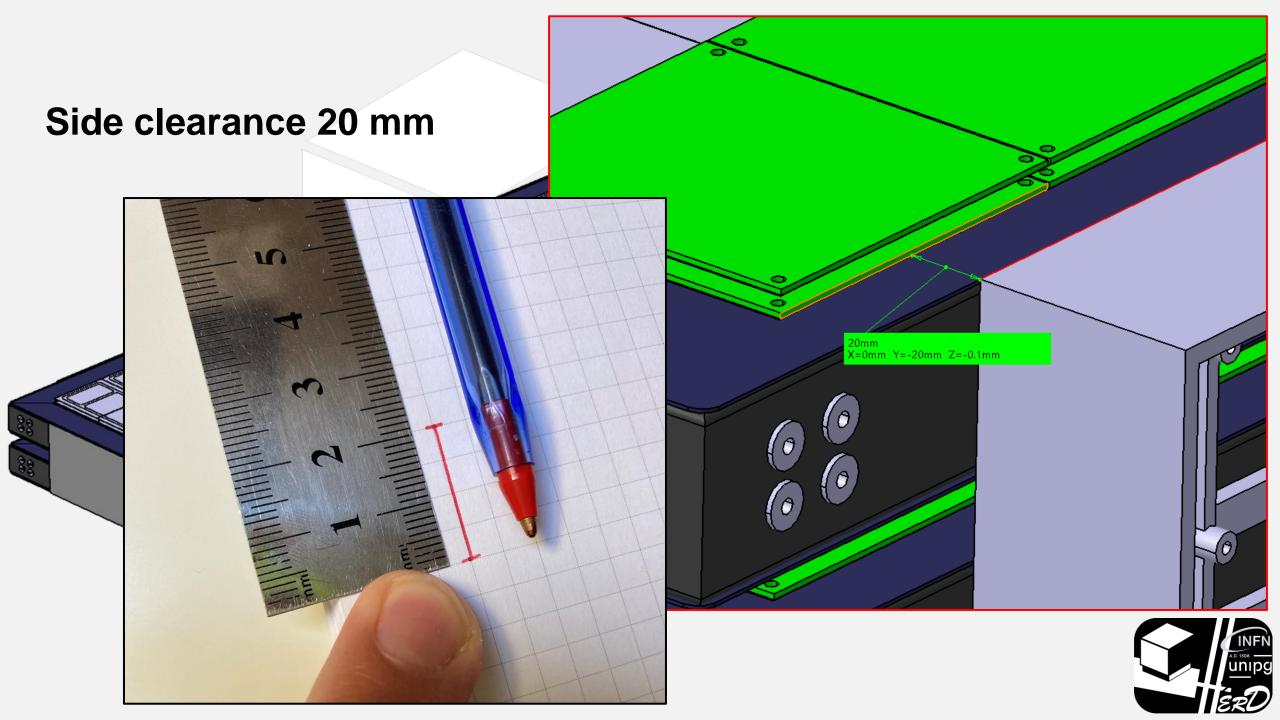
*Accounts for the PCB manufacturing accuracy

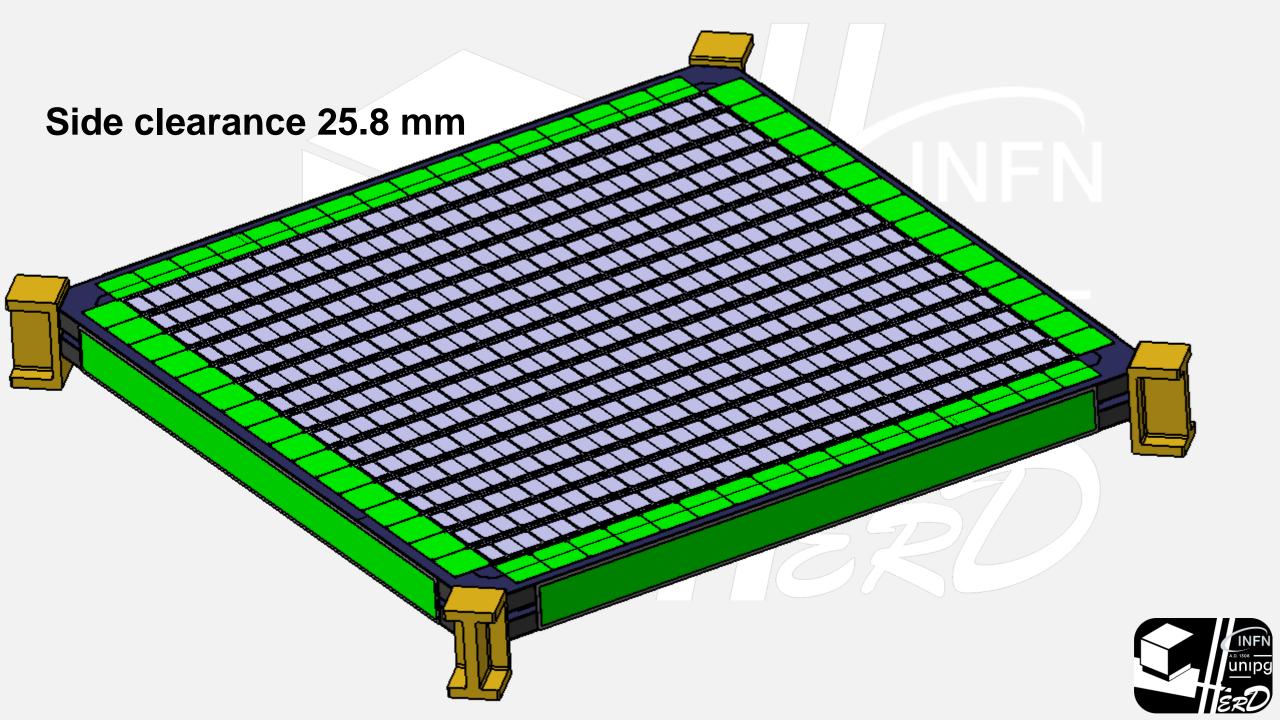


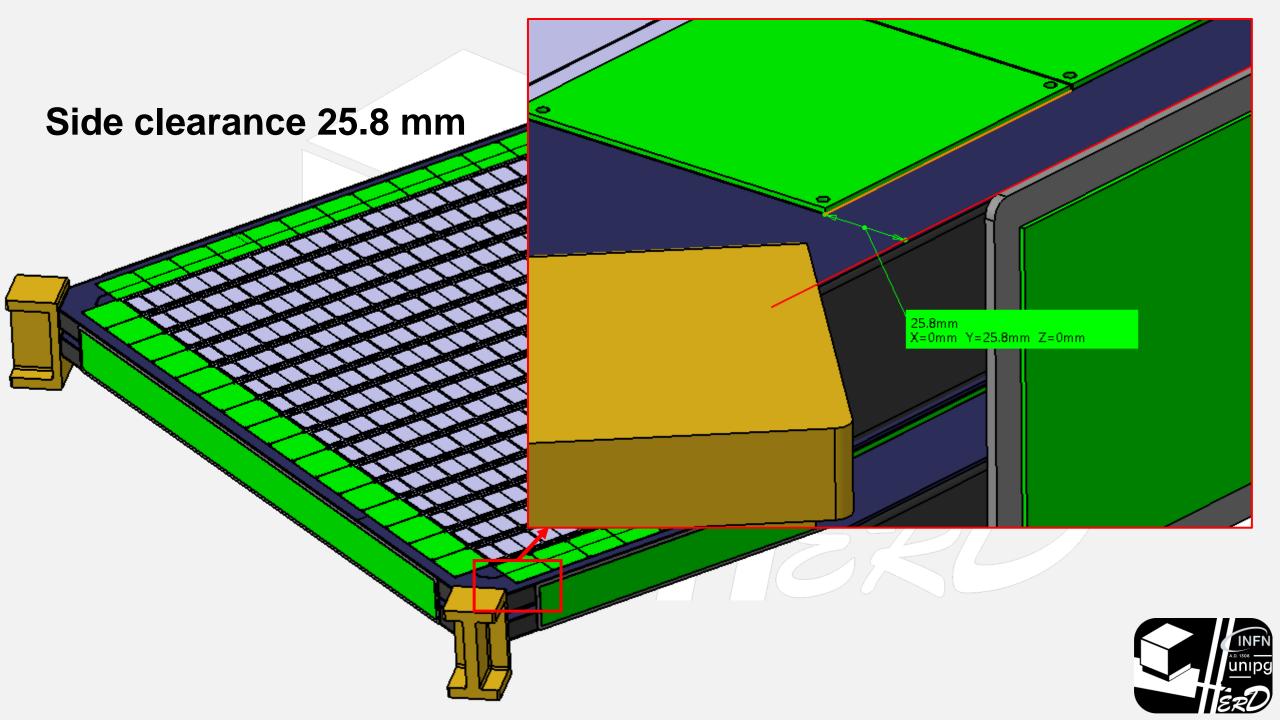
NOTE: in this design the front-end dimensions are the same for the top and the side

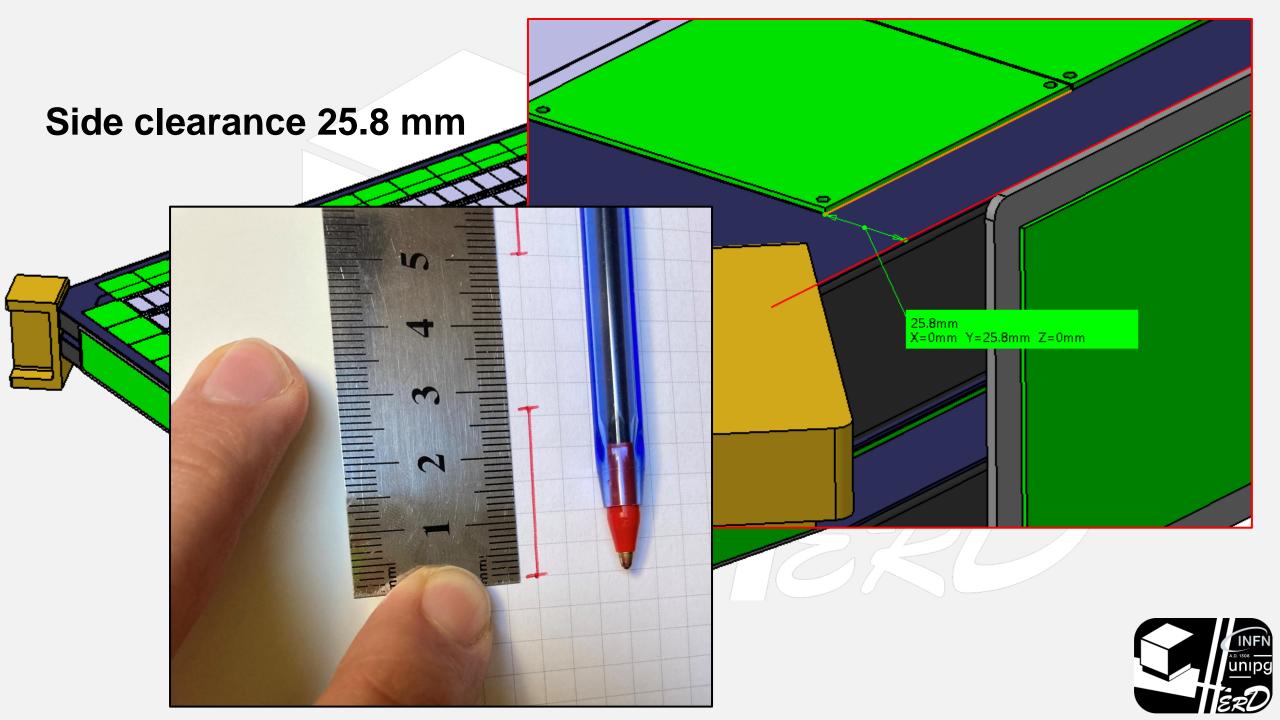












Thanks for the attention